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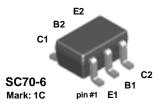
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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild guestions@onsemi.com.

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BC847S



NOTE: The pinouts are symmetrical; pin 1 and pin 4 are interchangeable. Units inside the carrier can be of either orientation and will not affect the functionality of the device.

NPN Multi-Chip General Purpose Amplifier

This device is designed for general purpose amplifier applications at collector currents to 200 mA. Sourced from Process 07.

Absolute Maximum Ratings* T_A = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CEO}	Collector-Emitter Voltage	45	V
V _{CES}	Collector-Base Voltage	50	V
V _{CBO}	V _{CBO} Collector-Base Voltage		V
V _{EBO}	Emitter-Base Voltage	6.0	V
Ic	Collector Current - Continuous 200		mA
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

1) These ratings are based on a maximum junction temperature of 150 degrees C.
2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics T_A = 25°C unless otherwise noted

Symbol	Characteristic	Max	Units	
		BC847S		
P _D	Total Device Dissipation	300	mW	
	Derate above 25°C	2.4	mW/°C	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	415	°C/W	

NPN Multi-Chip General Purpose Amplifier

(continued)

Electrical Characteristics

 $T_A = 25$ °C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
·						
OFF CHAR	RACTERISTICS					
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage	$I_C = 10 \text{ mA}, I_B = 0$	45			V
V _{(BR)CES}	Collector-Base Breakdown Voltage	$I_C = 10 \mu A, I_E = 0$	50			V
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_C = 10 \mu A, I_E = 0$	50			V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_E = 10 \mu A, I_C = 0$	6.0			V
I _{CBO}	Collector-Cutoff Current	$V_{CB} = 30 \text{ V}, I_{E} = 0$			15	nA
		$V_{CB} = 30 \text{ V}, I_{E} = 0, T_{A} = 150^{\circ}\text{C}$			5.0	μΑ

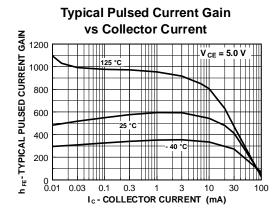
ON CHARACTERISTICS

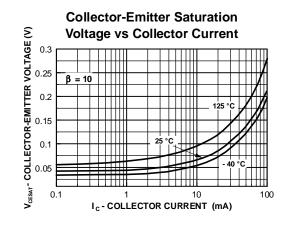
h _{FE}	DC Current Gain	$I_C = 2.0 \text{ mA}, V_{CE} = 5.0 \text{ V}$	110	630	
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C = 10 mA, I _B = 0.5 mA		0.25	V
		$I_C = 100 \text{ mA}, I_B = 5.0 \text{ mA}$		0.65	V
$V_{BE(on)}$	Base-Emitter ON Voltage	$I_C = 2.0 \text{ mA}, V_{CE} = 5.0 \text{ V}$	0.58	0.7	V
		$I_C = 10 \text{ mA}, V_{CE} = 5.0 \text{ V}$		0.77	V

SMALL SIGNAL CHARACTERISTICS

f⊤	Current Gain - Bandwidth Product	$I_C = 20 \text{ mA}, V_{CE} = 5.0,$ f = 100 mHz	200	MHz
C _{obo}	Output Capacitance	V _{CB} = 10 V, f = 1.0 MHz	2.0	pF

Typical Characteristics

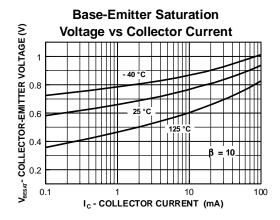


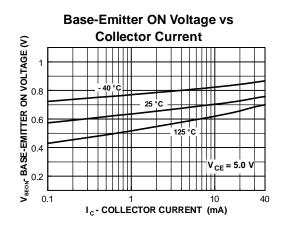


NPN Multi-Chip General Purpose Amplifier

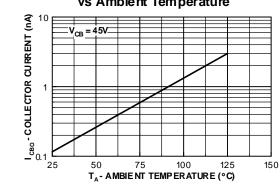
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Typical Characteristics

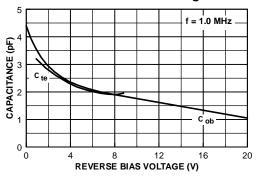




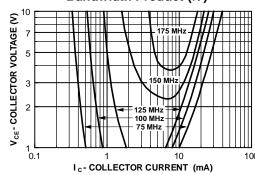
Collector-Cutoff Current vs Ambient Temperature



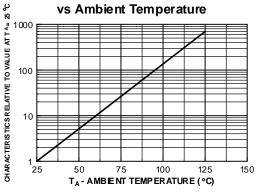
Input and Output Capacitance vs Reverse Bias Voltage



Contours of Constant Gain Bandwidth Product (f_T)



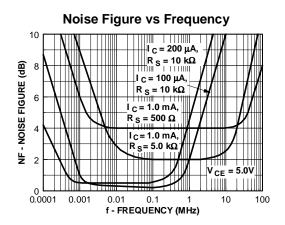
Normalized Collect or-Cutoff Current

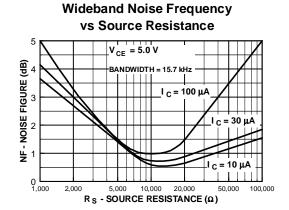


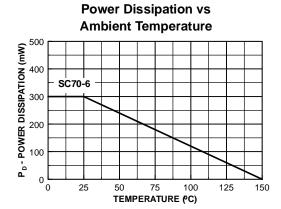
NPN Multi-Chip General Purpose Amplifier

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Typical Characteristics (continued)







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